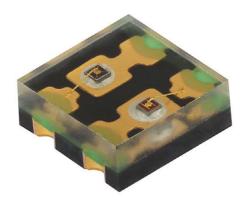


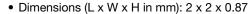
# Dual Color Emitting Diodes, 660 nm and 940 nm



### **FEATURES**

Package type: surface mount

• Package form: square PCB



• Peak wavelength:  $\lambda_p = 660 \text{ nm}$  and 940 nm

High reliability

· High radiant power

• Angle of half intensity:  $\varphi = \pm 60^{\circ}$ 

• Floor life: 168 h, MSL 3, according to J-STD-020

 Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



HALOGEN **FREE** 

**GREEN** 

### • Lead (Pb)-free reflow soldering

### **DESCRIPTION**

VSMD66694 is a dual color emitting device with 660 nm and 940 nm peak wavelength. The emitters are based on the <u>SurfLight<sup>TM</sup></u> technology, providing high radiant power.

### **APPLICATIONS**

- Wearables
- · Health monitoring
- · Pulse oximetry

PRODUCT SUMMARY					
COMPONENT	COLOR	I <sub>e</sub> (mW/sr)	φ (deg)	λ <sub>p</sub> (nm)	t <sub>r</sub> (ns)
VSMD66694	Red	2.3	± 60	660	10
VSIVID66694	IR	1.5	± 00	940	10

### Note

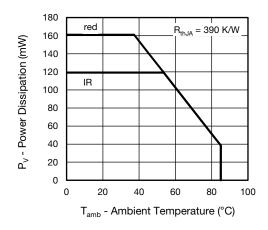
Test conditions see table "Basic Characteristics"

ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
VSMD66694	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	square PCB		

MOQ: minimum order quantity

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	COLOR	VALUE	UNIT
Reverse voltage		V <sub>R</sub>		5	V
Forward current			Red	70	- mA
Forward current		I <sub>F</sub>	IR	70	
Peak forward current	$t_p/T = 0.1, t_p = 100 \mu s$		Red	140	mA
reak forward current		I <sub>FM</sub>	IR	140	
Surge forward current	t <sub>p</sub> = 100 μs		Red	1	А
Surge forward current		I <sub>FSM</sub>	IR	1	
Power dissipation		В	Red	161	mW
Power dissipation		$P_V$	IR	119	
Junction temperature		Tj		100	°C
Operating temperature range		T <sub>amb</sub>		-25 to +85	°C
Storage temperature range		T <sub>stg</sub>		-25 to +85	°C
Soldering temperature	According fig. 10, J-STD-020	T <sub>sd</sub>		260	°C
Thermal resistance junction / ambient	J-STD-051	R <sub>thJA</sub>		390	K/W







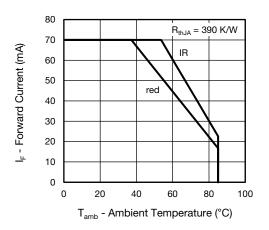
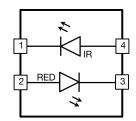


Fig. 2 - Forward Current Limit vs. Ambient Temperature

PARAMETER	TEST CONDITION	SYMBOL	COLOR	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 20 \text{ mA}, t_p = 20 \text{ ms}$	V <sub>F</sub>	Red	-	2.0	2.3	V
			IR	=	1.4	1.7	
Temperature coefficient	I <sub>F</sub> = 20 mA	TK <sub>VF</sub>	Red	=	-2.3	-	mV/K
			IR	=	-2.3	-	
Reverse current		I <sub>R</sub>	not o	designed for	reverse oper	ation	μΑ
lunation conscitones	$V_R = 0 V, f = 1 MHz,$		Red	-	7	-	pF
Junction capacitance	$E = 0 \text{ mW/cm}^2$	CJ	IR	-	5	-	
Padiant intensity	1 - 20 mA		Red	1.9	2.3	-	mW/sr
Radiant intensity	$I_F = 20 \text{ mA}$	l <sub>e</sub>	IR	0.8	1.5	-	
Dedient news	I <sub>F</sub> = 20 mA	фе	Red	=	9.5	-	mW
Radiant power			IR	=	8.5	-	
Angle of half intensity	I <sub>F</sub> = 20 mA	φ		=	± 60	-	deg
5	J 00 A	$\lambda_{p}$	Red	650	660	670	nm
Peak wavelength	$I_F = 20 \text{ mA}$		IR	920	940	960	
Spectral bandwidth	I <sub>F</sub> = 20 mA	Δλ	Red	-	20	-	nm
			IR	-	40	-	
Tompovetive exellisions of 3	I <sub>F</sub> = 20 mA	$TK_{\lambdap}$	Red	-	0.2	-	nm/K
Temperature coefficient of $\lambda_p$			IR	-	0.3	-	
Rise time	I <sub>F</sub> = 20 mA	t <sub>r</sub>	Red	-	10	-	ns
			IR	=	10	-	
Fall time	I <sub>F</sub> = 20 mA	t <sub>f</sub>	Red	-	10	-	ns
			IR	-	10	-	

### **CIRCUIT BLOCK DIAGRAM**



1	IR LED	IR cathode
2	RED LED	RED anode
3	RED LED	RED cathode
4	IR LED	IR anode

### BASIC CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

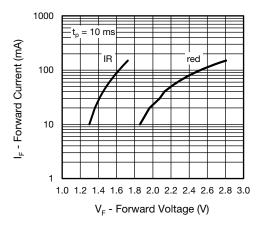


Fig. 3 - Forward Current vs. Forward Voltage

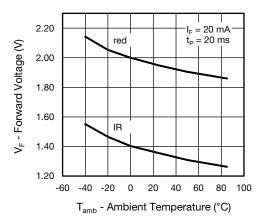


Fig. 4 - Forward Voltage vs. Ambient Temperature

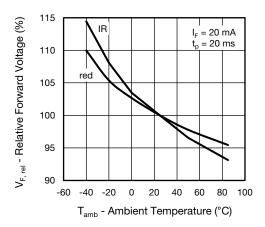


Fig. 5 - Relative Forward Voltage vs. Ambient Temperature

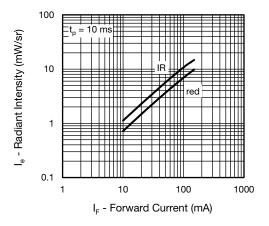


Fig. 6 - Radiant Intensity vs. Forward Current

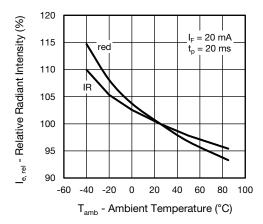


Fig. 7 - Relative Radiant Intensity vs. Ambient Temperature

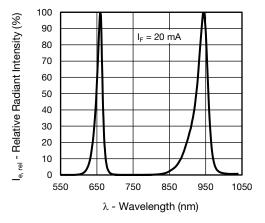


Fig. 8 - Relative Radiant Intensity vs. Wavelength



# DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

#### **FLOOR LIFE**

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 3

Floor life: 168 h

Conditions:  $T_{amb}$  < 30 °C, RH < 60 %

#### **DRYING**

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40  $^{\circ}$ C (+ 5  $^{\circ}$ C), RH < 5  $^{\circ}$ M.

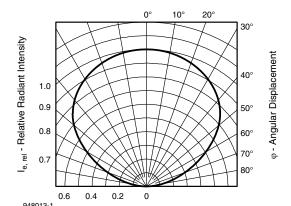


Fig. 9 - Relative Radiant Intensity vs. Angular Displacement

### **REFLOW SOLDER PROFILE**

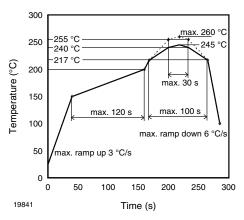
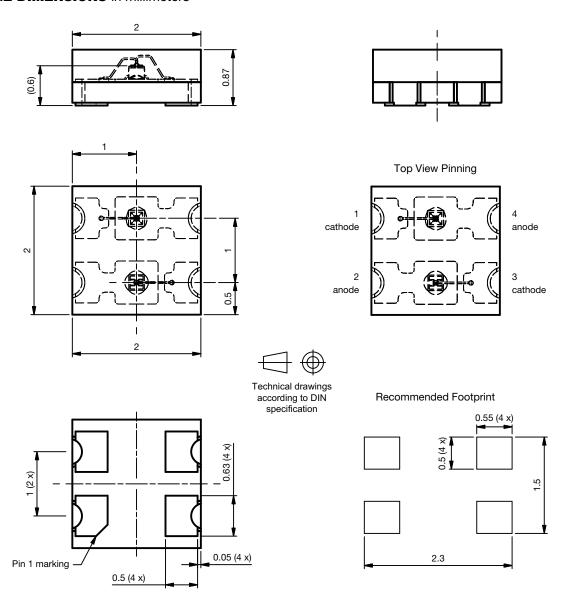


Fig. 10 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020



### **PACKAGE DIMENSIONS** in millimeters

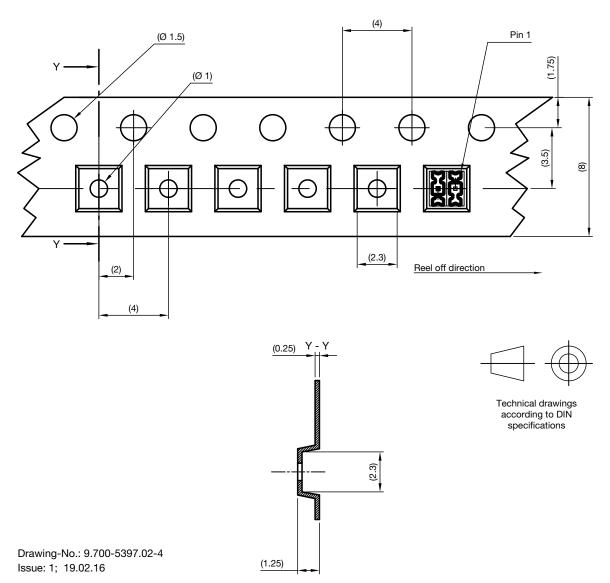


Drawing No.: 6.550-5347.01-4 Not indicated tolerances ± 0.1

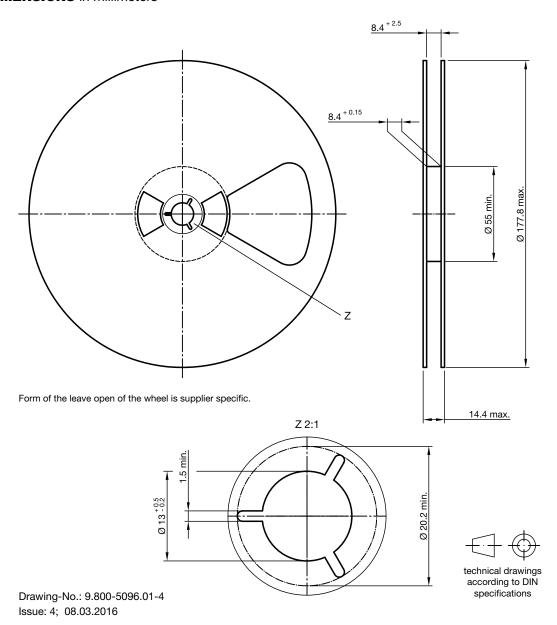
Issue: 1; 19.02.16



### **TAPE DIMENSIONS** in millimeters



### **REEL DIMENSIONS** in millimeters





### **Legal Disclaimer Notice**

Vishay

### **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.